Microheated Substrates for Patterning Cells and **Controlling Development**

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Abstract-Here, we seek to control cellular development by devising a means through which cells can be subjected to a microheated environment in standard culture conditions. Numerous techniques have been devised for controlling cellular function and development via manipulation of surface environmental cues at the micro- and nanoscale. It is well understood that temperature plays a significant role in the rate of cellular activities, migratory behavior (thermotaxis), and in some cases, protein expression. Yet, the effects and possible utilization of micrometer-scale temperature fields in cell cultures have not been explored. Toward this end, two types of thermally isolated microheated substrates were designed and fabricated, one with standard backside etching beneath a dielectric film and another with a combination of surface and bulk micromachining and backside etching. The substrates were characterized with infrared microscopy, finite element modeling, scanning electron microscopy, stylus profilometry, and electrothermal calibrations. Neuron culture studies were conducted on these substrates to 1) examine the feasibility of using a microheated environment to achieve patterned cell growth and 2) selectively accelerate neural development on regions less than 100 μm wide. Results show that attached neurons, grown on microheated regions set at 37 °C, extended processes substantially faster than those incubated at 25 °C on the same substrate. Further, unattached neurons were positioned precisely along the length of the heater filament (operating at 45 °C) using free convection currents. These preliminary findings indicate that microheated substrates may be used to direct cellular development spatially in a practical manner. [1414]

Index Terms-BioMEMS, cell patterning, microfabrication, microheater, neural development, neural outgrowth, thermal isolation.

I. INTRODUCTION

HE study of cellular developmental responses to environmental cues such as heat (e.g., [1]–[4]), topography (e.g., [5]-[8]), chemical and protein gradients (e.g., [9]-[14]), electromagnetic fields (EMF) (e.g., [15], [16]), etc. has the poten-

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tial to yield a better understanding of these complex behaviors in addition to practical utilization schemes. Technological advancements in the last few decades have allowed most of these environmental cues to be well characterized and controlled at the microscale. Interestingly, the effects of temperature on cellular development have been explored, but unlike other environmental cues, little attention has been given to temperature variations below the macroscopic scale.

The control of neuronal cells, in particular, has attracted much attention over the past decade because of the obvious significance involved in controlling their development. There is a need for the phases of neuronal development and repair to be controlled, optimized, and understood if nervous tissue is to be functionally integrated into prosthetics and native tissues or studied at the network level. In much the same manner as other environmental cues, the presence of microscale temperature deviations during different stages of development may provide a means for controlling neuron outgrowth in vitro-one marked advantage to this approach being the ability to switch the environmental cue off and on in situ. This is similar to EMF cues but in clear contrast to other cues such as topography and biochemical gradients.

In this research, we demonstrate temperature-based control of cell growth at the microscale. To achieve this, we developed microheaters suitable for producing microthermal gradients, establishing patterned growth, and patterning cells using free convection fields. Thermally isolated microheaters are utilized for various applications, (e.g., gas sensors, anemometers, micropumps, tunable optical fibers, direct thermal printing, etc.) and as a result, have been microfabricated into many forms depending upon the device functionality. The principal requirements for our microheated substrates were 1) that isolated heated regions be less than 100 μ m wide, 2) the surface topography be a negligible developmental factor (i.e., contain no sharp ridges, even at the submicron level [9]), 3) heated domains be positioned proximally so as to allow functional patterned growth, 4) operational temperatures be in the range of ambient to 45 °C with a precision of ± 4 °C, and 5) a closed-membrane-type heater be implemented.

II. FABRICATION

Two different methods were employed to fabricate the microheated substrates. In the first, standard anisotropic backside etching of the wafer was used (hereafter termed the "BE method"). In the second, a fabrication procedure was developed to achieve closely spaced, arbitrarily shaped microheaters using a combination of backside etching and surface and



Fig. 1. Cross-sectional schematic of the fabrication process for the backside-etched microheaters (BE method).

bulk micromachining (hereafter termed the "column-release method"). The former was used to generate preliminary cell culture results, while the latter demonstrates a means through which flat, closely spaced microheated regions may be realized.

A. BE Method

Frequently, backside etching techniques are used to produce thermally isolated structures because of the low number of fabrication steps involved. Double-side alignment, however, is needed for the bulk backside etching in this process, which decreases the precision of heater element placement within the membrane. Moreover, sloped sidewalls (54.74°) from anisotropic etching limit the proximity of heater elements to no less than $2t/\sqrt{2}$, where t is the wafer thickness.

Fabrication begins with a 6-inch, single-side polished, p-type (100) silicon wafer. A silicon oxide/nitride composite layer (300 Å/1500 Å) is first deposited as an etch stop via thermal oxidation and low-pressure chemical vapor deposition (LPCVD). Next, aluminum is sputtered to a thickness of 5000 Å and chemically etched beneath a mask into the desired circuit pattern. Then, plasma-enhanced tetraethoxysilane (PETEOS; 1 μ m-thick) is deposited, serving as a passivation layer, and is patterned through a second mask by reactive ion etching (RIE). Finally, a third mask is aligned on the wafer backside and KOH (35 wt%) is used to etch the wafer anisotropically for approximately 15 hr at 75°C, leaving behind the membrane containing the heater [see Fig. 1]. The wafer was then diced partially with anisotropically etched V-grooves that partition the individual devices for straightforward separation; mechanical dicing significantly increases the likelihood of membrane fracture.

B. Column-Release Method

Currently, there are many techniques available to produce closely spaced, thermally isolated heater elements (e.g., [17]–[20]), however the membranes can be structurally unstable, usually incapable of containing complex geometric heater patterns, provide limited thermal isolation, and contain sharp topographical features. The following method was conceptualized in order to sidestep these potential shortcomings.

The process begins with a 6-inch, 675 μ m-thick, single-side polished, p-type (100) silicon wafer. In the first step, a hightemperature furnace is used to grow a thermal oxide layer (300 Å), upon which a 1500 Å-thick silicon nitride (SiN) film is deposited using LPCVD. This composite layer serves as the hard mask layer in the final KOH etching process. Next, the SiN layer on the front side of the wafer is removed using an RIE process. This is followed by deposition of a 1 μ m-thick PETEOS layer that is patterned using the first mask to generate narrow trench structures on the wafer's surface. The pattern of exposed silicon is then etched by Deep RIE to a depth of $\sim 40 \ \mu m$ and a width of 3 μm [Fig. 2(a)], forming trenches with vertical sidewalls. The hard mask is then removed in a buffered oxide etching (BOE) solution. Subsequently, a doped oxide composite, phosphosilicate glass (PSG; 1 μ m) beneath borophosphosilicate glass (BPSG; 2.5 μ m), is deposited and smoothed via plasma-enhanced chemical vapor deposition (PECVD) and reflowed at 900°C in N_2 . The PSG serves as an excellent sacrificial layer in the final release process due to its higher etch rate in a hydrofluoric acid (HF) solution. At this stage the trenches are refilled partially, as illustrated in Fig. 2(b), due to the nonconformal deposition characteristics of the PECVD process. This will, nevertheless, prove to be advantageous in a later step since the short oxide etching path releases the hanging columns more rapidly. In the next step, the composite layer is plasma etched back to level with the original wafer surface [see Fig. 2(c)]. Another layer of PSG (1 μ m) is deposited and patterned with a second mask to selectively cover the refilled trench area. Then, a tensile-stressed, 1 μ m-thick PECVD SiN layer is deposited, followed by a 5000 Å-thick PECVD TEOS layer [see Fig. 2(d)]. The nitride layer is an etch stop for the eventual HF release process and helps balance the compressive stress within the TEOS layer. Next, a chrome and gold composite layer (Cr 400 Å/Au 3000 Å) is sputtered and patterned with a third mask to create the heater circuitry that is then passivated with another PETEOS (5000 Å) layer [see Fig. 2(e)]. The electrical contact sites are exposed by dry oxide etching through a fourth mask [see Fig. 2(f)]. As seen in Fig. 2(f), the device is functional but there is limited thermal isolation at this point. In the following step [see Fig. 2(g)], the wafer backside is masked and etched in a KOH solution (35 wt%) at 75 °C until the filled oxide layer is exposed, which creates hanging columns [see Fig. 2(h)]. Finally, a buffered HF solution is used to etch away the bottom refilled oxide layer, thereby releasing the columns and leaving behind the intact thin-film structure [see Fig. 2(i)]. The final device may be seen in Fig. 2(j). Wafers were diced in the same manner mentioned above. The potential for proximity of the independent structures is of particular value, as compared to the minimum allowable spacing of conventional backside-etched heaters that is dictated by the wafer thickness.



Fig. 2. Cross-sectional schematic of the fabrication steps for the column-release method and corresponding scanning electron micrographs for four of the fabrication stages (a, b, i, and j). Note that the dotted circles indicate the locations of the "zoomed-in" views.

Importantly, the multilayers of the membrane were thermally stress balanced during fabrication so as to reduce residual stress and prevent membrane cracking. Between each heater element are silicon "ribs" [see Fig. 2(j)] that provide additional structural support and act as heat sinks to draw conducted heat away from the film surface. Note that the DRIE trench depth can be adjusted to control the heat-sinking capacity and accommodate larger temperature fluxes.

C. Final Devices

Microheated substrates were packaged by gluing them to a printed circuit board (PCB), wire bonding the contact sites to the PCB pads, and soldering in leads. A 35-mm polystyrene Petri dish (BD FalconTM) with a precut, 1.5 cm-wide hole was then attached to the top of the device with silicone adhesive (Selleys) and placed in a 70 °C oven for 10 min to cure. Consequently, the only surfaces contacting the culture medium during cell experiments were the Petri dish, silicone adhesive, and surface of the heater.

Preliminary cell studies were conducted on microheaters fabricated by the first protocol described; these membranes only contained a single heating element. An additional set of microheaters were created with the same fabrication procedure, but instead, five sensor elements one-third the width of the heater element were incorporated into the membrane and surrounding passivation layer to act as independent electrical resistance thermometers [see Fig. 3(a)]. Three heater configurations were prepared using the column-release method detailed above: a parallel arrangement [see Fig. 3(b)], a nodal array [see Fig. 3(c)], and circular heaters [see Fig. 3(d)]. Infrared (IR) images (see Section III), illustrating the localized heating from the microheaters in Fig. 3(a)–(d), are shown in Fig. 3(e)–(h).

III. CHARACTERIZATION

A. Electrothermal Behavior

For most conductors, a linear approximation to the resistance-temperature (R-T) curve is adequate within a narrow temperature range, thus heater and sensor elements were calibrated in this manner. Briefly, microheaters were placed on a hotplate (Linkam stage with TMS94 programmer), covered with a glass beaker to minimize ambient temperature fluctuations, and allowed to equilibrate for 3 min at each set temperature. A potentiostat (μ Autolab II with GPES 4.8) was used to record corresponding resistances at eight to twelve temperature values between room temperature and 50 °C.



Fig. 3. Optical (a–d) and IR (e–h) micrographs of the top surfaces of (a) a heater with five sensor elements, (b) a parallel arrangement, (c) a nodal array, and (d) circular heaters. All experiments were conducted in air. A linear grayscale bar denotes the corresponding temperatures estimated from the R-T curves for each device. Note that the range of heating temperatures used for the IR microscopy experiments was much higher so that images with higher contrast could be acquired. The temperatures still dropped to ambient near the membrane edges at these high temperatures; the fact that these experiments were conducted in air should be considered, however.

The data was fit using least-squares linear regression [see Fig. 4(a) and (b)]. It was assumed that the sample current used to measure the circuit's resistance was small enough to avoid error from Joule heating. Calibrations performed in air were used during IR observation—discussed in Section III-B—while

those carried out in the culture medium were used during cell experiments. Following calibration, the potentiostat was used to drive the heater at various currents while resistance values for the five sensors were monitored with a multimeter (Fluke 70 111). Note that the effects of slightly heating the leads and



Fig. 4. Calibration plots for (a) five sensor elements and (b) the heating element of a microheater that was fabricated by the BE method; (c) sensor resistance versus microheater current for the five sensor elements taken during Joule heating of the microheater; (d) input power versus heater resistance showing the large fluctuation in temperature for a small initial power input.

wire bonds were considered negligible, given that more than 98% of the circuit resistance was contained within the microheated region. As seen in Fig. 4(c), only "sensor 1," embedded within the membrane, responded to the increase in heat, which demonstrates the degree of thermal isolation provided by the membrane. A very minimal amount of power was required to increase the heater temperature initially, and beyond that point the relationship was almost linear [see Fig. 4(d)]. Although we found the precision adequate for our purposes, it is worth noting that this could be improved further if necessary, as described below. The resistance of a wire is given by the following relation:

$$R(T) = \frac{\rho(T)L}{A} \tag{1}$$

where $\rho(T)$ is the temperature-dependent resistivity, L is the length of the heater, and A is the cross-sectional area. In order to improve the temperature accuracy of the heaters, the resistance of the heating element should be increased. Increasing L and/or decreasing A can achieve this. The electron mean free path for Au and Al is ~ 10–30 nm at room temperature [21]–[23], and the maximum resolution of lithography used to etch the heater patterns is approximately 0.8 μ m. Thus, using the current fabrication methods, the practical dimensional limits of the heater cross-section are 1.0 × 0.1 μ m. The maximum theoretical circuit resistance would approach 2.5 k Ω for Au and Al heaters of these dimensions.

At a fixed voltage, the heater current will drift until equilibrium is reached between the heater and its surroundings. Hence, to operate precisely in constant-temperature mode, some form of electronic feedback is needed to maintain a constant resistance. This can be accomplished by incorporating the heater into a Wheatstone bridge, setting the voltage, and having an op-amp maintain a balanced bridge [24]. In these preliminary experiments, the voltage was adjusted manually to sustain a relatively constant heater temperature $(\pm 2 \ ^{\circ}C)$.

B. Infrared Microscopy

At any temperature, a perfect emitter of radiation of all wavelengths is considered a black body. Planck's law relates the spectral emissive power of a black body to its temperature through the following:

$$M(\lambda) = \frac{C_1}{\lambda^5 \exp\left(\frac{C_2}{\lambda T}\right) - 1} \tag{2}$$

where λ is the wavelength in μ m, T is absolute temperature, and $C_1 (= 3.742 \times 10^{-16} \text{ Wm}^2)$ and $C_2 (= 1.438 \times 10^{-2} \text{ mK})$ are the first and second radiation constants, respectively. Real materials are not black bodies, but within narrow wavelength and temperature ranges can be considered "grey bodies" wherein the above equation holds true if the emissivity value of a material is considered.

An IR photoemission microscope with a mercury-cadmiumtelluride focal plane array, sensitive in the range of 800–2500 nm, was used to image the microheaters in air during Joule heating. Refer to [25]–[27] for specific instrument details. Fig. 3(e)–(h) shows IR images of all four device configurations. Corresponding intensity and temperature plots are given in Fig. 5, where temperature was related to intensity through (2). All data were passed through a smoothing algorithm to help filter noise. Unfortunately, intensity-temperature calibrations were not possible because the IR radiation of the thermal chuck passed readily through the thin membrane, i.e., emissivity values estimated for the membrane and heating element were some weighted average of the substrate and chuck. For this reason,



Fig. 5. Infrared microscopy linescans showing normalized intensity and calculated temperature values (a) perpendicular to the heating element of a BE-method microheater, (b) perpendicular to the heating elements of a parallel array, and (c) along the length of a heating element from a BE-method microheater.

normalized values of intensity and temperature vs. position were plotted to show a general trend, and the maximum was estimated from an R-T curve. Furthermore, IR experiments were conducted in air because water strongly absorbs IR radiation. For all devices, a sharp temperature gradient was observed. In the BE heaters, temperature was reduced 90% before reaching the edge of the membrane [see Fig. 5(a)]. On the other hand, heat was less attenuated across each membrane within the parallel array, and baseline values near the center heater were elevated [see Fig. 5(b)]. As illustrated in Fig. 5(c), the temperature along the axis of the heater dropped near the end, yet could be considered constant along 88% of the heating element length.

C. Finite Element Modeling

To help optimize heater design and to validate the IR data and sensor readings independently, two-dimensional (2-D) steadystate heat conduction and free-convection flow simulations were performed with the finite element model program ANSYS 7.0. Material property values found in the literature [28] were used. The simulation confirmed our experimental measurements, which showed that if the microheater is run at a low temperature (e.g., up to +30 °C above ambient) the temperature drops rapidly to ambient temperature at or near the membrane's edge. This is due to the heat-sinking capacity of the supporting silicon substrate. Accordingly, it can be expected that, when used at low temperatures, our microheaters have no significant thermal effect on cells grown away from the membrane. This allows us to impart distinct temperature differences between cells grown on the membrane and those grown at any other location. It is expected that the presence of a mass of cells will influence the proximal thermal fields, thus simulations that incorporate such inhomogeneities will be needed to carefully define the temperature state throughout the cell structure.

In addition to growing cells under different thermal conditions, there was also an interest to exploit convection currents to position cells on the microheater substrate. To determine the effective range for gathering cells and patterning them on the heater membrane, a free convection simulation was run at various microheater temperatures in a water environment [see Fig. 6]. The model showed that unattached cells resting more than 200 μ m from the membrane could be moved toward the heater at a rate of approximately 2–15 μ m/min using temperatures ranging from 15–30 °C above ambient. This result was confirmed experimentally using time-lapse videos of cell movement (see Section IV).

D. Surface Topography

A profilometer (KLA-Tencor P-10) was used to evaluate the surface topography of each of the five different microheater membrane regions. Maximum slope values (rise/run) of the surface features were determined to be 0.94, 0.22, 0.41, and 0.45 for the BE (with and without sensors), parallel, nodal array, and circular heater configurations, respectively. Profilometer scans across the entire membrane at the heater midpoint also elucidated the maximum amount of residual stress remaining in the heater structures due to thermal mismatching during fabrication. An insignificant curvature, κ , was observed in every case other than the parallel configuration. The large membrane width (800 μ m), coupled with the high aspect ratios of the support structures below, could explain the small warpage observed in the parallel configuration. If $R_c \gg w \gg d'$ then κ can be approximated by

$$\kappa = \frac{1}{R_c} = \frac{8d'}{w^2} \tag{3}$$



Fig. 6. ANSYS 2-D cross-sectional simulations of steady-state (a) heat conduction through water above the surface of a BE-method microheater when operating at 42 °C and (b) free convection velocities within the culture medium above the same type of microheater operating at 25 °C above room temperature. Independent time-lapse video showed cell velocities up to 17 μ m/s at this temperature. Plots were graphically formatted to improve clarity.

where R_c is radius of curvature, w is the width of the membrane (chord), and d' is the chordal deviation (0.25 × maximum height of warpage) [29]. Using (3), R_c was found to be 2520 μ m for the parallet configuration, suggesting that the thermal-stress balancing was effective.

IV. CELL CULTURE

Cell growth and patterning experiments were conducted with C17.2 cells, a multipotent neural stem cell line generated by retrovirus-mediated v-myc transfer into murine cerebellar progenitor cells [30]. Cells were cultured in 25 cm² polystyrene flasks (Flacon) and high-glucose Dulbecco's Modified Eagle's Medium (DMEM; Sigma) containing 10% fetal bovine serum (FBS; Sigma) and 5% horse serum (HS; Sigma) for 2–3 days, or until confluence reached > 80%, and kept in standard humidified 5% CO₂ at 37°C. Prior to experimentation, the microheaters were sterilized with 70% ethanol for 30 min, then thoroughly rinsed with 1X phosphate-buffered solution (PBS) and dried with a stream of nitrogen. Cultured cells were removed

from the flask by pouring out the medium, rinsing twice with PBS (1X), adding 1.5 ml of 0.25% trypsin (1X), and waiting 5 min until sufficient detachment was achieved. The suspended cells were then mixed with an equal volume of DMEM, collected by centrifugation at 1000 rpm for 5min, and gently resuspended in 4 ml of serum-free DMEM. The cell suspension was then diluted and pipetted onto the surface of the microheater at a cell density of 5000 to 30000cells/cm² (~ 10 to 50% confluence), depending upon the type of experiment conducted. For cell heating experiments, substrates were placed back into an incubator for 2 h to allow for adequate attachment. In contrast, cell patterning involved the movement of cells by free convection, hence attachment would have been a hindrance and experiments were run within 5min of cell deposition. Following attachment, differentiation of C17.2 cells was induced by gently removing the serum-free DMEM and replacing it with an N2-supplement/DMEM-F12 solution (1:1; Invitrogen).

V. RESULTS AND DISCUSSION

A. Heating Attached Neurons

Most mammalian cells seem to be preprogrammed to function optimally around 37 °C and will alter their physiological behavior to maintain this temperature state, from migration along thermal gradients to the release of heat-shock proteins [31]. Therefore, there are two approaches to heating cells: 1) dropping the ambient temperature below 37 °C and operating the heater at 37 °C (attracting mode) or 2) maintaining a physiological ambient temperature and operating the heater above 37 °C (repelling mode). The former was chosen to demonstrate microscale temperature-based control over cell growth. In this scenario, cells grown within the microheated region are given a metabolic advantage over their neighbors (developing at a much lower temperature). It has been shown, for example, that the metabolic activity in neurons cultured at 22 °C is slowed significantly, thus delaying differentiation and extending the viability of the cells by several days [1]. In Fig. 7(a), cells were in culture for 18 h at 25 °C while the microheater was kept at approximately 37 °C. Cells grown on the membrane differentiated and extended long processes while neurons developing at 25 °C showed subtle morphological changes. A set of control studies were conducted by culturing neurons at both room temperature and 37 °C for more than 24 hr on the microheater substrates without supplying power to the heaters [see Fig. 7(b)]. Results showed randomly oriented outgrowth, which demonstrates a lack of appreciable topographical or chemical influence from the substrate's surface on cellular development. While general observations of characteristic outgrowth were made, a quantitative analysis of cell morphology was not performed in this study, i.e., calculations of zero-, first-, and second-order moments for each cell. For further details, refer to [32] for a proposed approach to estimating extension and dispersion based upon cell moments.

The ability to switch an environmental cue off and on, and/or vary the intensity *in situ*, has exciting potential for understanding cell development and behavior. In this manner, neural differentiation and outgrowth can be potentially coordinated and locally regulated to influence the polarity of specific



Fig. 7. Optical micrographs of a BE substrate illustrating (a) spatially selective acceleration of neural outgrowth by heating cells grown on the microheated membrane, (b) control experiment demonstrating random growth in the absence of thermal gradients (spherical cells are unattached and undifferentiated), and (c) collecting and patterning unattached neurons using free-convection currents.

cell-cell interconnections, or prevent them altogether. Moreover, microheated substrates can be utilized to investigate the overall cellular response when neural structures such as the growthcone, soma, dendrites, and axon are heated independently. It is unknown, for instance, which portions of a neuron are able to sense a temperature variation and initiate the appropriate migration or outgrowth response, or if the response is altered after the cell has developed fully. An understanding of this may provide insight into differences in mechanisms of signal transduction between developing and fully matured cells.

B. Patterning Neurons Using Convection

During the initial stages of attachment, weak cell-substrate interaction forces are formed as the cells approach the surface. The heater was turned on after the undifferentiated neurons settled to the surface but prior to the establishment of strong attachment forces. On account of the small volume of fluid being heated, convection currents reached a steady state within seconds of powering the microheater, allowing for the precise timing of cell movement. Further, adjusting the heater temperature altered the resulting velocity gradient near the surface. An example of cell patterning can be seen in Fig. 7(c), in which a room-temperature cell suspension with a density of $\sim 5000 \,\mathrm{cells/cm^2}$ was pipetted onto the substrate and after 5 min the heater was powered and kept at 45°C for 15 min. The neurons appeared to slide across the surface toward the heater or, occasionally, looked as though they were rolling. It should be noted that because the cells were probably at a lower temperature than the heater, and because they were heated for a relatively short period of time, there were no signs of cellular damage and normal neuronal growth ensued after patterning in this manner.

Convection experiments were straightforward with the important parameters being heater temperature and cell density. Using this method, it is possible to force cells to aggregate locally, or by lowering the cell density, collect cells in a single-file fashion. One significant advantage of being able to aggregate cells locally on the microscale is explained below. In highdensity culture conditions, cells have been shown to ignore environmental cues in favor of biochemical vectors emanating from surrounding cells (e.g., growth factors). Thus, the cell density is often lowered during experimentation in order to study the effects of certain cues independently, but for the cells to survive, their medium may need to be supplemented with that of a high-density culture. Therefore, microheated substrates can be used to create smaller regions of high cell confluence, and hence improve culture conditions surrounding a low-confluence area wherein the effects of cell-cell interactions are minimized and the influence of other environmental cues can be studied.

The importance of patterned and oriented growth in tissue engineering is not limited to neurons, however. Many tissues rely on a specific cellular alignment and orientation to function properly. For example, endothelial cells, which line the interior of blood vessels, are oriented so that their major axis is perpendicular to the direction of blood flow. Moreover, skeletal muscle contains cells that are highly oriented and packed tightly. These types of requirements give rise to difficulties when engineering useful tissues.

VI. CONCLUSION

Two types of thermally isolated microheated substrates were fabricated and characterized. The microheaters met our criteria of having smooth closed-membrane surfaces, sufficient thermal isolation on the microscale, and allowing for arbitrarily patterned heating regions. Experimental measurements and simulations confirmed that the microheater substrates were sufficiently precise and accurate for our experimental purposes. Using our devices, it was demonstrated that microheated environments can be used to 1) pattern cells using free convection and 2) accelerate neural development selectively within heated regions. We believe that being able to control (i.e., switch on and off and vary intensity) cellular cues on the microscale will lead to a greater understanding of cellular development and may eventually lead to practical methods for patterning and integrating cells into microelectronic devices.

To improve the accuracy of the heater element, and to better define the thermal profile along the width of the membrane and surrounding substrate, new microheaters are being fabricated that have a sensor less than 2 μ m from the heater and two additional sensors within the membrane. Furthermore, these sensor elements will have a much smaller cross-section to increase their nominal resistance.

Recently, a microheater array was used in conjunction with a thermo-responsive polymer coating to create patterned adhesion sites for cell growth [33]. Though the microheaters were not thermally isolated and the patterned region was approximately 1mm, the study demonstrates the possibility of using microheated regions to control the timing of attachment and to form cell patterns at the microscale. Hence, the concept of using a thermally isolated microheated region as a developmental switch can be incorporated into many existing methods of locally manipulating cellular development.

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